
International Conferences to be held in Asia

ICEE 2009 (International Conference on Electrical Engineering) Towards A Safe, Reliable, Sustainable, Intelligent Power System

Dates: July 5-9, 2009
Place: Shenyang, China
Organizer: The Chinese Society for Electrical Engineering (CSEE)

Co-organizers:

Institute of Electrical Engineers of Japan (IEEJ)
The Korean Institute of Electrical Engineers (KIEE)
The Hong Kong Institution of Engineers (HKIE)

The ICEE is a major event that will annually provide an exceptional venue for networking an international group of practicing electrical engineers and experts to highlight key issues and developments essential to the multifaceted field of electrical engineering systems.

The conference adds some prevailing topics like UHV technology, disaster prevention and control technology for power grid safety, DG, smart grid etc. for discussion.

Important dates:

Abstract Submission December 31, 2008
Full Paper Submission April 1, 2009
Notification of Full Paper Acceptance May 1, 2009

Secretariat:

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ICPADM 2009 (International conference on Properties and Applications of Dielectric Materials)

Dates: July 19-23, 2009
Place: Harbin, China
Chairman: Prof. Lei Qingquan, (Harbin University of Science and Technology)

The 9th International conference on Properties and Applications of Dielectric Materials (ICPADM2009) will be held in Harbin, China on July 19-23, 2009. The conference will be sponsored by the IEEE Dielectrics and Electrical Insulation Society (DEIS), and

technically supported by China Electrotechnical Society and Chinese Society of Electrical Engineering (CSEE).

The purpose of this conference is to provide a forum for researchers, scientists and engineers from all over the world to exchange ideas and discuss recent progress in electrical insulation, dielectric and practical applications. The organizing committee cordially invites you to participate in the conference.

Important dates:

Abstract Submission: March 9, 2009
Manuscript Submission: May 18, 2009

Secretariat:

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CMD 2010 (International Conference on Condition Monitoring and Diagnostics)

Dates: September 11-14, 2010
Venue: Shibaura Institute of Technology, Tokyo, Japan
Chairman: Prof. Hitoshi Okubo (Nagoya University, Nagoya, Japan)

The conference will be sponsored by the Institute of Electrical Engineers of Japan (IEEJ) and technically co-sponsored by IEEE DEIS and CIGRE. Conference slogan is "Modern Asset Management Technology for Green Operation".

Important dates:

Abstract Submission: January 31, 2010
Manuscript Submission: May 30, 2010

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